SURFACE MOUNT CHIP LED LAMP SPECIFICATION

● COMMODITY: SURFACE MOUNT CHIP LED LAMP

• DEVICE NUMBER: BL-HY035A PAGE: 2

●ELECTRICAL AND OPTICAL CHARACTERISTICS (Ta=25°C)

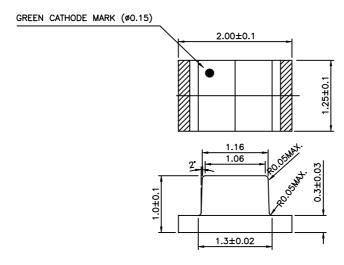
Chip				Absolute Maximum				Electro-optical				
	Peak	Dominant	Lens	Rating				Data (At 20mA)			Viewing Angle	
Emitted Color	Wave Length	Wave Length	Appearance	Δλ	Pd	If	Peak		(V)	Iv 7 (m	Гур. cd)	$\begin{array}{c} 2\theta 1/2 \\ \text{(deg)} \end{array}$
	$\lambda p(nm)$	$\lambda d(nm)$		(nm)	(mW)	(mA)	If(mA)	Тур.	Max.	Min	Тур.	· • • • • • • • • • • • • • • • • • • •
Yellow	585	585±5	Water Clear	35	100	30	100	2.2	2.6	2.7	7.0	120

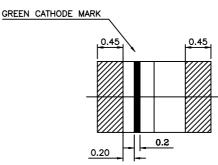
Remark: Viewing angle is the Off-axis angle at which the luminous intensity is half the axial luminous intensity.

●ABSOLUTE MAXIMUM RATINGS (Ta=25°C)

Reverse Voltage			5V
Reverse Current (V _R =5V)			
Operating Temperature Range	25°C	\sim	80° C
Storage Temperature Range	30℃	\sim	85℃

■PACKAGE DIMENSIONS





NOTES: 1.All dimensions are in millimeters (inches).

- 2. Tolerance is \pm 0.10mm (0.004) unless otherwise specified.
- 3. Specifications are subject to change without notice.
- 4. Condition for IFp is pulse of 1/10 duty and 0.1 msec width.



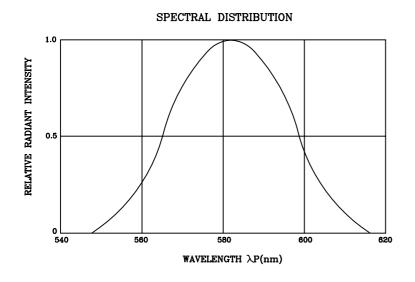
REVISION:

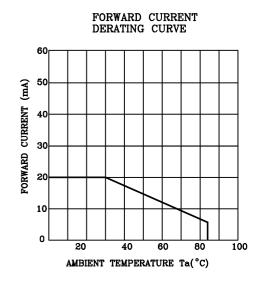
1.0

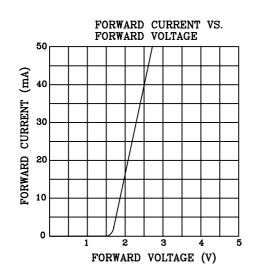
LED LAMPS SPECIFICATION

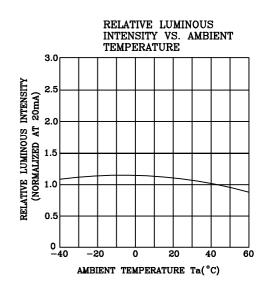
- COMMODITY:SURFACE MOUNT TOP LED LAMP
- DEVICE NUMBER: BL-HY035A
- ELECTRICAL AND OPTICAL CHARACTERISTICS(Ta=25°C)

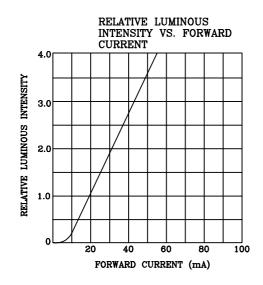


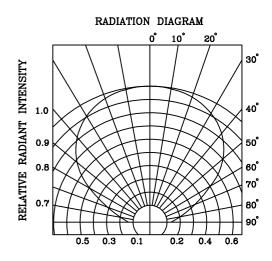












SURFACE MOUNT CHIP LED LAMP SPECIFICATION

RELIABILITY TEST

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Classification	Test Item	Reference Standard	Test Conditions	Result	
	Operation Life	MIL-STD-750:1026	Connect with a power If=20mA	0/20	
		MIL-STD-883:1005 JIS C 7021 :B-1	Ta=Under room temperature Test time=1,000hrs		
	High		Ta=+65°C±5°C		
	Temperature	MIL-STD-202:103B	RH=90%-95%	0/20	
Endurance	High Humidity	JIS C 7021 :B-11	Test time=1,000hrs	0/20	
Test	Storage				
Test	High	MIL-STD-883:1008	High Ta=+85°C±5°C		
	Temperature	JIS C 7021 :B-10	Test time=1,000hrs	0/20	
	Storage	JIS C /021 .D-10			
	Low		Low Ta=-35 $^{\circ}$ C±5 $^{\circ}$ C		
	Temperature	JIS-C-7021 :B-12	Test time=1,000hrs	0/20	
	Storage				
	Temperature	MIL-STD-202:107D	$ -35^{\circ}\text{C} \sim +25^{\circ}\text{C} \sim +85^{\circ}\text{C} \sim +25^{\circ}\text{C} $		
	Cycling	MIL-STD-750:1051	60min 20min 60min 20min	0/20	
		MIL-STD-883:1010	Test Time=5cycle		
		JIS C 7021 :A-4			
	Thermal Shock	MIL-STD-202:107D	+85°C±5°C ~-35°C±5°C		
Environmental Test		MIL-STD-750:1051	20min 20min	0/20	
		MIL-STD-883:1011	Test Time=10cycle		
	Solder		Preheating:		
	Resistance	MIL-STD-202:201A	140° C -160° C ,within 2 minutes.		
		MIL-STD-750:2031	Operation heating:	0/20	
		JIS C 7021 :A-1	235 °C (Max.), within 10		
			seconds.(Max.)		

JUDGMENT CRITERIA OF FAILURE FOR THE RELIABILITY

Measuring items	Symbol	Measuring conditions	Judgement criteria for failure			
Forward voltage	$V_{F}(V)$	If=20mA	Over Ux1.2			
Reverse current	Ir(uA)	Vr=5V	Over Ux2			
Luminous intensity	Iv (mcd)	If=20mA	Below SX0.5			

Note: 1.U means the upper limit of specified characteristics. S means initial value.

2.Measurment shall be taken between 2 hours and after the test pieces have been returned to normal ambient conditions after completion of each test.

SURFACE MOUNT CHIP LED LAMP SPECIFICATION

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1. **SOLDERING:**

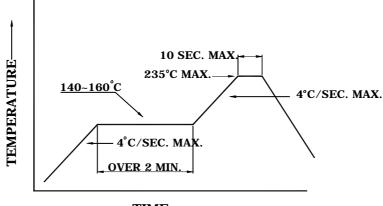
Manual Of Soldering

The temperature of the iron tip should not be higher than 300° C (572°F) and Soldering within 3 seconds per solder-land is to be observed.

Reflow Soldering

Preheating: $140^{\circ}\text{C} \sim 160^{\circ}\text{C} \pm 5^{\circ}\text{C}$, within 2 minutes. Operation heating: 235°C (MAX.) within 10 seconds.(Max)

Gradual Cooling (Avoid quenching).



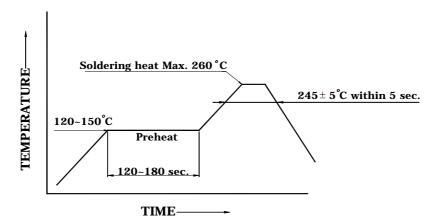
TIME-

DIP soldering (Wave Soldering)

Preheating: 120° C~150°C, within 120~180 sec.

Operation heating: $245^{\circ}\text{C}\pm5^{\circ}\text{C}$ within $5 \sec.260^{\circ}\text{C}$ (Max)

Gradual Cooling (Avoid quenching).



2. **Handling:**

Care must be taken not to cause to the epoxy resin portion of BRIGHT LEDs while it is exposed to high temperature. Care must be taken not rub the epoxy resin portion of BRIGHT LEDs with hard or sharp article such as the sand blast and the metal hook

